



PTC thermistors for overcurrent protection in telecom applications

Leadless round disks

Series/Type:

Date: November 2009

Overcurrent protection for telecom
Leadless round disks
Applications

- Overcurrent protection for telecom applications
- Suitable for MDF applications e.g. connectors etc.

Features

- Designed for combined usage of PTC and primary protection (e.g. gas arrester)
- Suitable for continuous connection to mains voltages of 110/230 V AC in tripped (high-ohmic) condition
- Matching available with narrow resistance tolerance
- Tight resistance matching maintained after switching
- Negligible resistance drift after soldering or switching
- RoHS-compatible

Options

- Alternative tolerances and resistances on request

Delivery mode

- Packed in blister trays

General electrical data

| | | | | |
|-----------------------------|-------------|-----------|----------|------|
| Max. operating voltage | | V_{max} | 245 | V AC |
| Operating temperature range | (V = 0) | T_{op} | -20/+125 | °C |
| Operating temperature range | (V = 230 V) | T_{op} | 0/+70 | °C |

Electrical specifications and ordering codes¹⁾

| Type | R_R | ΔR_R | $R_{25,match}$ (per packing unit) $ R_1 - R_2 _{max}$ | I_R @ 25°C | I_R @ 70°C | I_S @ 25°C | I_{Smax} @ 230 V AC | t_s (typ.) @ I_{Smax} , 230 V AC | Ordering code |
|--|----------|--------------|---|--------------------|--------------------|--------------------|-----------------------------|--|-----------------|
| | Ω | % | Ω | mA | mA | mA | A | s | |
| Round disks, contacts for clamp connection | | | | | | | | | |
| A93 | 4.75 | ±15 | 0.9 | 160 | 70 | 370 | 1.0 | 4 | B59093A0080B110 |
| A95 | 9.3 | ±10 | 0.4 | 110 | 50 | 250 | 0.5 | 12 | B59095A0080B110 |
| Round disks, contacts for solder connection | | | | | | | | | |
| A1037 | 10 | ±15 | No | 140 | 95 | 300 | 1.0 | 2.0 | B59037A1120B010 |
| A1037 | 10 | ±15 | 1.0 | 140 | 95 | 300 | 1.0 | 2.0 | B59037A1120B110 |
| A1042 | 10 | ±15 | 1.0 | 150 | 100 | 300 | 1.0 | 4.0 | B59042A1120B110 |
| A1041 | 25 | ±15 | 1.0 | 100 | 65 | 200 | 2.8 | 0.2 | B59041A1120B110 |
| A1044 | 35 | ±15 | 1.0 | 90 | 55 | 180 | 2.8 | 1.15 | B59044A1120B110 |

1) Variation of current and switching time with heat dissipation of mounting assembly must be taken into account.

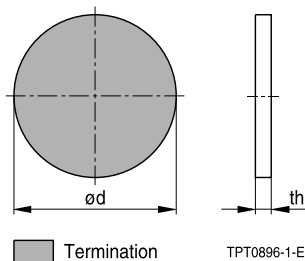
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Reliability data

| Test | Standard | Test conditions | $ \Delta R_{25}/R_{25} $ |
|--------------------------------|-------------|---|--------------------------|
| Electrical endurance, cycling | IEC 60738-1 | Room temperature, I_{Smax} ; V_{max} Number of cycles: 10 | < 20% |
| Electrical endurance, constant | IEC 60738-1 | Storage at V_{max}/T_{op} Test duration: 1000 h | < 25% |
| Damp heat | IEC 60738-1 | Temperature of air: 40 °C Relative humidity of air: 93% Duration: 56 days Test according to IEC 60068-2-78 | < 10% |

Dimensional drawing



Dimensions in mm

| Type | $\varnothing d_{max}$ | th_{max} | Contacts |
|--------------------|-----------------------|------------|-----------------------|
| Round disks | | | |
| A1037 | 6.6 | 1.7 | for solder connection |
| A1041 | 8.1 | 2.1 | for solder connection |
| A1042 | 8.1 | 2.1 | for solder connection |
| A1044 | 8.1 | 2.1 | for solder connection |
| A93 | 7.9 | 2.1 | for clamp connection |
| A95 | 7.8 | 2.6 | for clamp connection |

Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature $-25\text{ °C} \dots +45\text{ °C}$, relative humidity $\leq 75\%$ annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.

Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

Symbols and terms

| | |
|-----------------|---|
| A | Area |
| C_{th} | Heat capacity |
| f | Frequency |
| I | Current |
| I_{max} | Maximum current |
| I_R | Rated current |
| I_{PTC} | PTC current |
| I_r | Residual current |
| $I_{r,oil}$ | Residual current in oil (for level sensors) |
| $I_{r,air}$ | Residual current in air (for level sensors) |
| I_{RMS} | Root-mean-square value of current |
| I_S | Switching current |
| I_{Smax} | Maximum switching current |
| LCT | Lower category temperature |
| N | Number (integer) |
| N_c | Operating cycles at V_{max} , charging of capacitor |
| N_f | Switching cycles at V_{max} , failure mode |
| P | Power |
| P_{25} | Maximum power at 25 °C |
| P_{el} | Electrical power |
| P_{diss} | Dissipation power |
| R_{min} | Minimum resistance |
| R_R | Rated resistance |
| ΔR_R | Tolerance of R_R |
| R_P | Parallel resistance |
| R_{PTC} | PTC resistance |
| R_{ref} | Reference resistance |
| R_S | Series resistance |
| R_{25} | Resistance at 25 °C |
| $R_{25,match}$ | Resistance matching per reel/ packing unit at 25 °C |
| ΔR_{25} | Tolerance of R_{25} |
| T | Temperature |
| t | Time |
| T_A | Ambient temperature |
| t_a | Thermal threshold time |
| T_C | Ferroelectric Curie temperature |

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| | |
|-----------------|---|
| t_E | Settling time (for level sensors) |
| T_R | Rated temperature |
| T_{sense} | Sensing temperature |
| T_{op} | Operating temperature |
| T_{PTC} | PTC temperature |
| t_R | Response time |
| T_{ref} | Reference temperature |
| T_{Rmin} | Temperature at minimum resistance |
| t_S | Switching time |
| T_{surf} | Surface temperature |
| UCT | Upper category temperature |
| V or V_{el} | Voltage (with subscript only for distinction from volume) |
| V_{RMS} | Root-mean-square value of voltage |
| V_{BD} | Breakdown voltage |
| V_{ins} | Insulation test voltage |
| $V_{link,max}$ | Maximum link voltage |
| V_{max} | Maximum operating voltage |
| $V_{max,dyn}$ | Maximum dynamic (short-time) operating voltage |
| V_{meas} | Measuring voltage |
| $V_{meas,max}$ | Maximum measuring voltage |
| V_R | Rated voltage |
| V_{PTC} | Voltage drop across a PTC thermistor |
| α | Temperature coefficient |
| Δ | Tolerance, change |
| δ_{th} | Dissipation factor |
| τ_{th} | Thermal cooling time constant |
| λ | Failure rate |
| e | Lead spacing (in mm) |

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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